Approved by:	
Checked by:	
Issued by:	

SPECIFICATION

PRODUCT: SAW FILTER

MODEL: HDIF389B1D



SHOULDER ELECTRONICS LIMITED

1.SCOPE

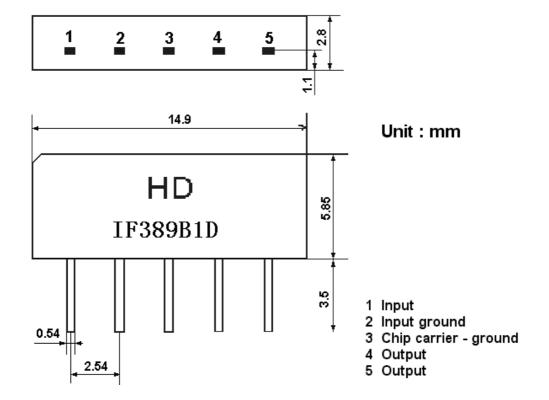
SHOULDER'S SAW filter series have broad line up products meeting all broadcast standard including NTSC,PAL and SECAM systems. These filters are composed of two interdigital transducers on a single-crystal. piezoelectrical chip. they are used in electronic equipments such as TV and so on.

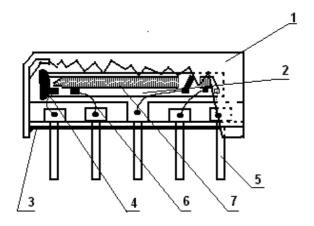
2. Construction

2.1 Dimension and materials

Manufacturer's name: SHOULDER ELECTRONICS Co. LTD(CHINA)

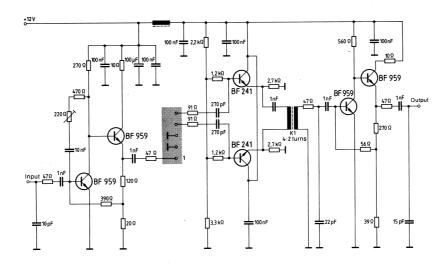
Type: IF389B1D





Components	Materials
1.Outer casing	PPS
2.Substrate	Lithium niobate
3.Base	Epoxy resin
4.Absorber	Epoxy resin
5.Lead	Cu alloy+Au plate
6.Bonding wire	AlSi alloy
7.Electrode	Al

2.2. Circuit construction, measurement circuit



Test circuit for SIP-5 filter Input impedance of the symmetrical post-amplifier: 2 k $\!\Omega$ in parallel with 3 pF

3. Characteristics

	Items	Conditions	Specifications
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Standard	atmos pheric conditi ons	Unless otherwise specified, the standard rang of atmospheric conditions for making measurements and tests is as follows; Ambient temperature: 15°C to 35°C Relative humidity: 25% to 85% Air pressure: 86kPa to 106kPa	There shall be no damage.
Operating	temper ature rang	Operating temperature rang is the rang of ambient temperatures in which the filter can be operated continuously10°C ~ +60°C	
Storage	temper ature rang	Storage temperature rang is the rang of ambient temperatures at which the filter can be stored without damage. Conditions are as specified elsewhere in these specifications40°C ~ +70°C	
Reference	temper ature	+25°C	

3.1 Maximum Rating

DC voltage VDC	12	\mathbf{V}	Between any terminals
AC voltage Vpp	10	V	Between any terminals

 $T_A=25$ °C

3.2 Electrical Characteristics

Source impedance $Z_s=50\Omega$ Load impedance $Z_L=2k\Omega//3pF$

Items Freq Min max typ Insertion attenuation 37.40MHz 16.1 17.6 19.1 dB Reference level Relative attenuation 38.90MHz 4.2 5.7 7.2 dB 2.3 dB 34.47MHz 3.8 5.3 32.40MHz 18.8 20.3 dB 33.40MHz 19.4 dB 20.9 30.90MHz 42.0 58 dB

		40.40MHz	40.0	52		dB
		41.40MHz	40.0	50		dB
Sidelobe	25.00~	30.90MHz	35.0	45		dB
	40.40~	45.00MHz	35.0	42		dB
Group delay p	redistortion		-	-65	-	ns
(reference free	(reference frequency 38.90 MHz)		-	0	-	ns
36.50 MHz						
		34.47MHz				
Impedance at	37.40 MHz					
	Input: Zin	n = Rin // Cin	-	2.2//10.7	-	kΩ//pF
0	utput Zout	=Rout // Cout	-	3.1//2.8	-	kΩ//pF
Тетр	erature coeffi	cient		-72		Ppm/k

3.3 Environmental Performance Characteristics

Item	Condition	n	Specifications
High temperature Low temperature	The specimen shall be store 80±2°C for 96±4h. Then it standard atmospheric condition which measurement shall be a The specimen shall be store -20±3°C for 96±4h. Then it standard atmospheric condition which measurement shall be a	shall be subjected to itions for 1h, after made within 1h. at a temperature of shall be subjected to itions for 1h, after	
Humidity Thermal shock	The specimen shall be store 40±2°C with relative humidit 96±4h. Then it shall be su atmospheric conditions for measurement shall be made w. The specimen shall be subjected to standard atmospheric to standard atmospheric to standard atmospheric to standard atmospheric within 1h. Temperature	measurement shall be made within 1h. Decimen shall be store at a temperature of C with relative humidity of 90% to 96% for Then it shall be subjected to standard otheric conditions for 1h, after which rement shall be made within 1h. Decimen shall be subjected to 8 continuous each as shown below. Then it shall be need to standard atmospheric conditions for ter which measurement shall be made 1h. Temperature Duration +25 °C=>-40 °C 4h -40 °C=>+85 °C 4h +85 °C=>+25 °C 0.5h	
Resistance to	Reflow soldering method		-

Soldering	Peak: 255 ±5 °C, 220 ±5 °C, 40s	
heat	At electrode temperature of the specimen.	
	Temperature profile of reflow soldering Soldering Slow cooling (Store at room temperature) Pre-heating 1 to 2 min. 1 to 2 min. 2 min. or more	
	The specimen shall be passed through the reflow furnace with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1h, after which the measurement shall be made. Test board shall be 1.6 mm thick. Base material shall be glass fabric base epoxy resin.	
Solder ability	Immerse the pins melt solder at 260°C+5/-0°C	More then 95% of
	for 5 sec.	total area of the
		pins should be
		covered with solder

3.4 Mechanical Test

Items	Conditions	Specifications
Vibration	600-3300rpm amplitude 1.5mm	There shall be no
	3 directions 2 H each	damage.
Drop	On maple plate from 1 m high 3 times	
Lead pull	Pull with 1 kg force for 30 seconds	
Lead bend	90° bending with 500g weigh 2 times	

3.5 Voltage Discharge Test

Item	Condition	Specifications
Surge	Between any two electrode	There shall be no
	100V 1000pF 4Mohm	damage

3.6 Frequency response

